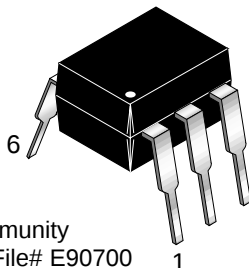


DESCRIPTION

The MOC8020 and MOC8021 are photodarlington-type optically coupled optocouplers. The devices have a gallium arsenide infrared emitting diode coupled with a silicon darlington phototransistor.

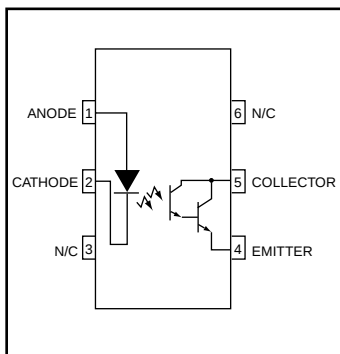
FEATURES

- High current transfer ratio
-500% (MOC8020)
-1000% (MOC8021)
- No base connection for improved noise immunity
- Underwriters Laboratory (UL) recognized File# E90700

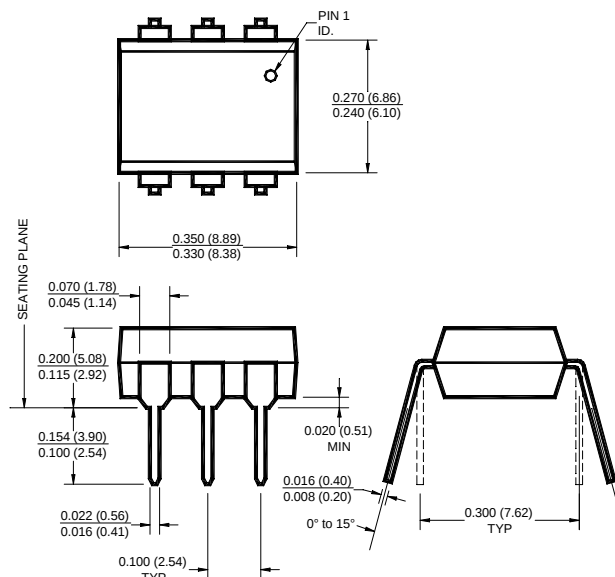


APPLICATIONS

- Appliances, measuring instruments
- I/O interface for computers
- Programmable controllers
- Portable electronics
- Interfacing and coupling systems of different potentials and impedance
- Solid state relays



PACKAGE DIMENSIONS



NOTE

All dimensions are in inches (millimeters)

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless otherwise specified.)

Parameter	Symbol	Value	Units
TOTAL DEVICE			
Storage Temperature	T _{STG}	-55 to +150	°C
Operating Temperature	T _{OPR}	-55 to +100	°C
Lead Solder Temperature	T _{SOL}	260 for 10 sec	°C
Total Device Power Dissipation @ T _A = 25°C	P _D	250	mW
Derate above 25°C		2.94	mW/°C
Input-Output Isolation Voltage	V _{ISO}	5300	Vac(rms)
EMITTER			
DC/Average Forward Input Current	I _F	60	mA
Reverse Input Voltage	V _R	3	V
LED Power Dissipation @ T _A = 25°C	P _D	120	mW
Derate above 25°C		1.41	mW/°C
DETECTOR			
Collector-Emitter Voltage	V _{CEO}	50	V
Detector Power Dissipation @ T _A = 25°C	P _D	150	mW
Derate above 25°C		1.76	mW/°C
Continuous Collector Current	I _C	150	mA

MOC8020

MOC8021

ELECTRICAL CHARACTERISTICS (T_A = 25°C Unless otherwise specified.)

INDIVIDUAL COMPONENT CHARACTERISTICS

Parameter	Test Conditions	Symbol	Min	Typ**	Max	Unit
EMITTER						
Input Forward Voltage	(I _F = 10 mA)	V _F		1.15	2	V
Input Capacitance	(V _F = 0, f = 1 MHz)	C _{IN}		18		pF
Reverse Leakage Current	(V _R = 3.0 V)	I _R		0.05	10	μA
DETECTOR						
Collector-Emitter Breakdown Voltage	(I _C = 1.0 mA)	BV _{CEO}	50			V
Emitter-Collector Breakdown Voltage	(I _E = 100 μA)	BV _{ECO}	5			V
Collector-Emitter Dark Current	(V _{CE} = 10 V)	I _{CEO}			100	nA

TRANSFER CHARACTERISTICS

DC Characteristic	Test Conditions	Symbol	Min	Typ**	Max	Units
Current Transfer Ratio, Collector-Emitter	MOC8020 (I _F = 10 mA, V _{CE} = 5 V) MOC8021 (I _F = 10 mA, V _{CE} = 5 V)	CTR	500			%
			1000			
Collector-Emitter Saturation Voltage	(I _F = 10 mA, I _C = 25 mA)	V _{CE(SAT)}			2	V

TRANSFER CHARACTERISTICS

Characteristic	Test Conditions	Symbol	Min	Typ**	Max	Units
SWITCHING TIMES						
Turn-on Time	(V _{CC} = 10 V, R _L = 100Ω, I _F = 5 mA)	t _{on}		3.5		μs
Turn-off Time		t _{off}		95		μs

ISOLATION CHARACTERISTICS

Characteristic	Test Conditions	Symbol	Min	Typ**	Max	Units
Input-Output Isolation Voltage	(I _{I-O} ≤ 1 μA, 1 min.)	V _{ISO}	7500			Vac(pk)
	(I _{I-O} ≤ 1 μA, 1 min.)		5300			Vac(rms)
Isolation Resistance	(V _{I-O} = 500 VDC)	R _{ISO}	10 ¹¹			Ω
Isolation Capacitance	(f = 1 MHz)	C _{ISO}		0.5		pf

Note

** Typical values at T_A = 25°C

Fig. 1 Output Current vs. Input Current

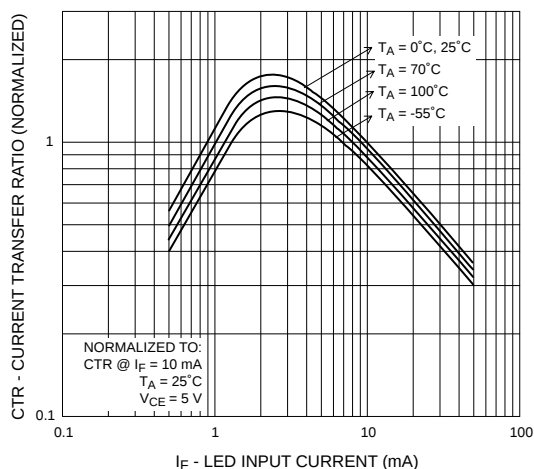


Fig. 2 Current Transfer Ratio vs. Ambient Temperature

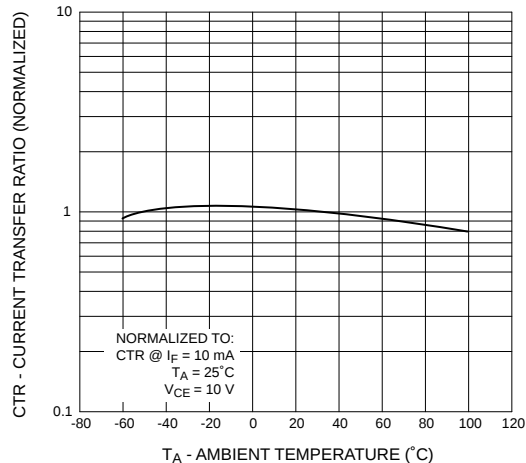


Fig. 3 Collector Current vs. Collector-Emitter Voltage

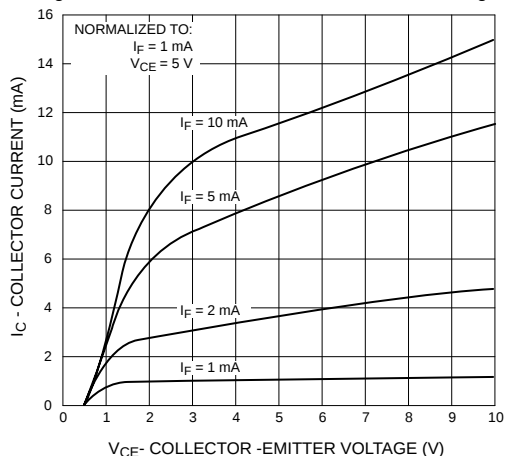


Fig. 4 Dark Current vs. Ambient Temperature

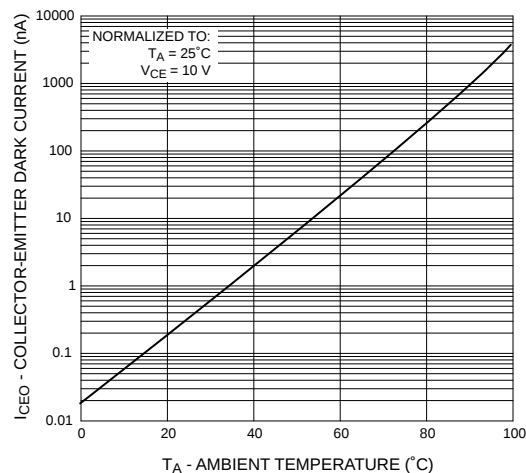


Fig. 5 Turn-On Time vs. Input Current

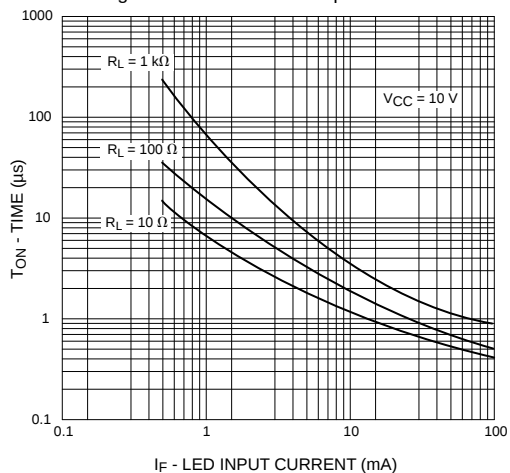
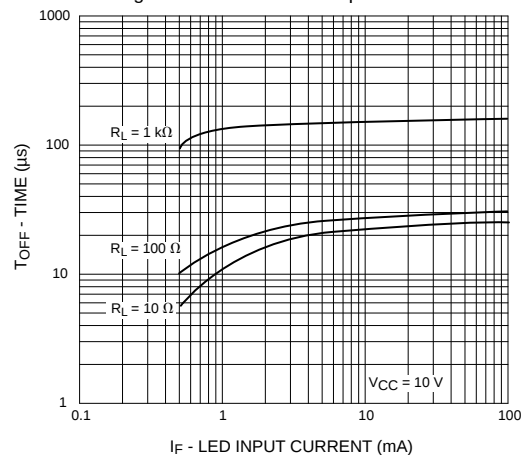


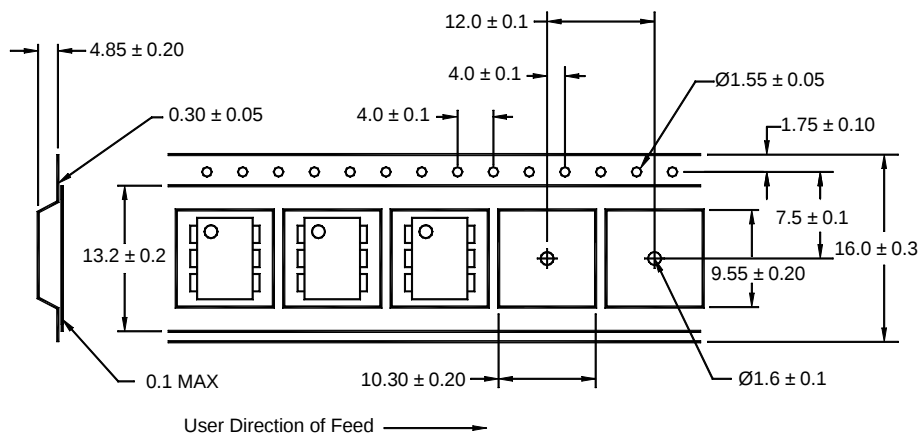
Fig. 6 Turn-Off Time vs. Input Current



ORDERING INFORMATION

Option	Order Entry Identifier	Description
S	.S	Surface Mount Lead Bend
SD	.SD	Surface Mount; Tape and reel
W	.W	0.4" Lead Spacing
300	.300	VDE 0884
300W	.300W	VDE 0884, 0.4" Lead Spacing
3S	.3S	VDE 0884, Surface Mount
3SD	.3SD	VDE 0884, Surface Mount, Tape & Reel

QT Carrier Tape Specifications ("D" Taping Orientation)



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